



Nanofabrication - direct write and replication patterning technologies in EUMINAfab

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[14-09-2010, E-MRS Warszawa]



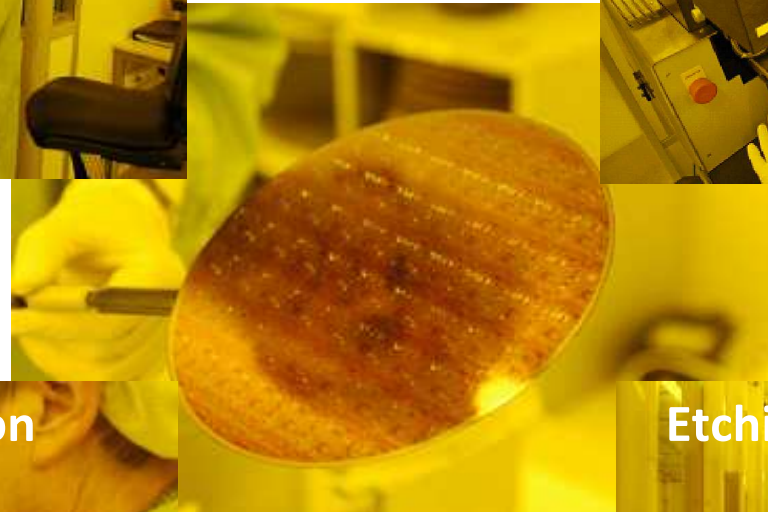
IMS Nanofabrication

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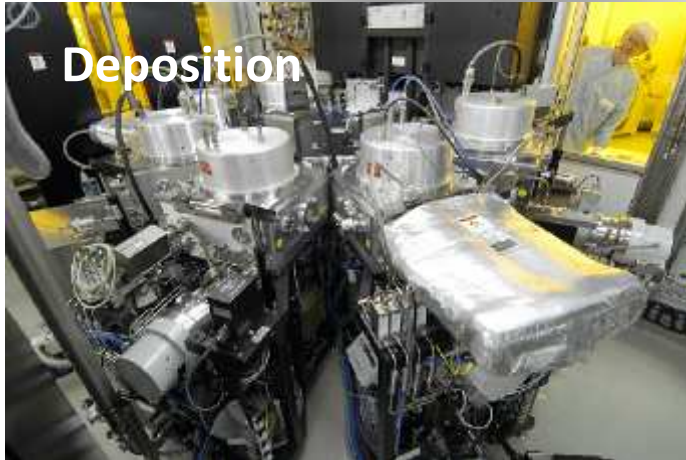
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- ★ II. NIL vs. soft printing
- ★ III. SCIL
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- ★ VI. Conclusion

the Thin Film Tool Box



Equipment

Deposition



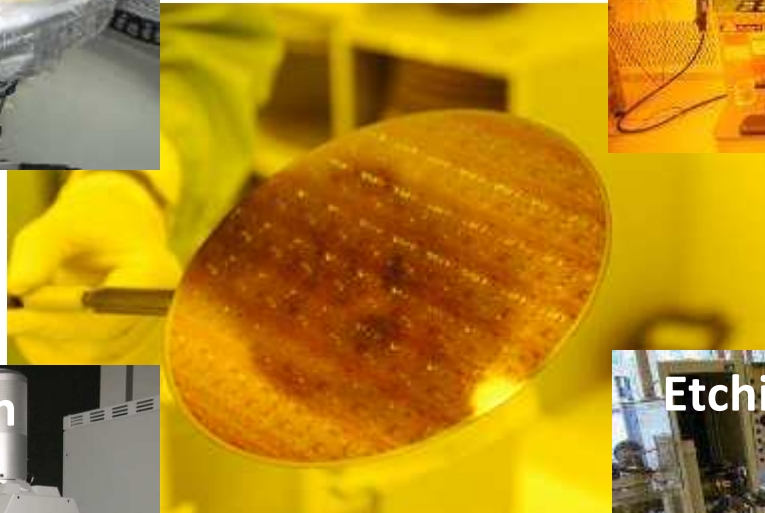
Lithography



Etching



Measuring/inspection



Lithography in EuminaFab



	optical contact	optical stepper	charged particle e-beam
Resolution	1 um	400 nm	10 nm
Ease of use	++	+	o
Flexibility	++	o	++
Through-put	o	++	--
Costs eqpt	low	high	very high
Cost per wafer	moderate	low	high

Ultra-High Resolution E-Beam Lithography

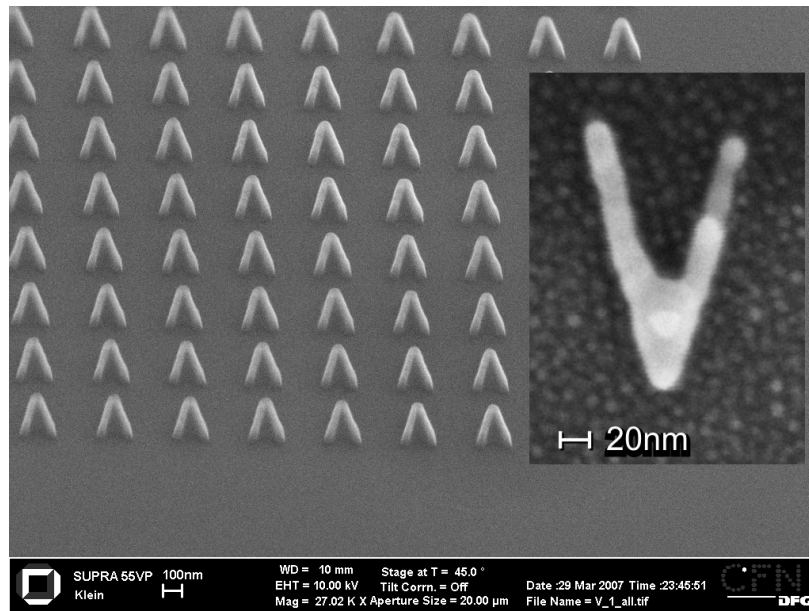


VB6 UHR EWF, Vistec @ KIT

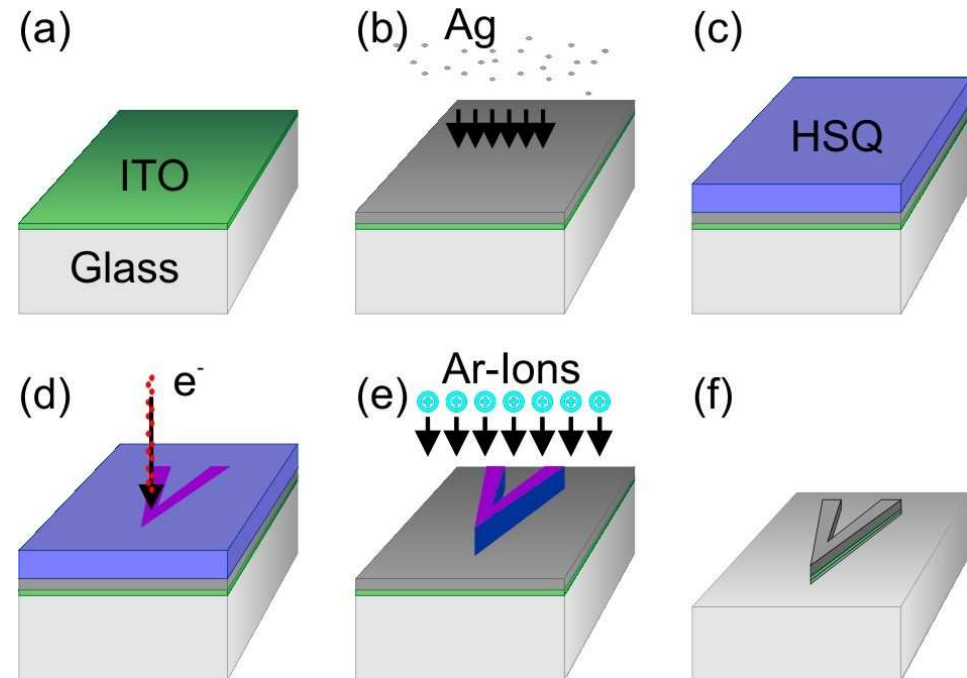


Jeol JBX9300 @ MiPlaza

Ultra-High Resolution E-Beam Lithography



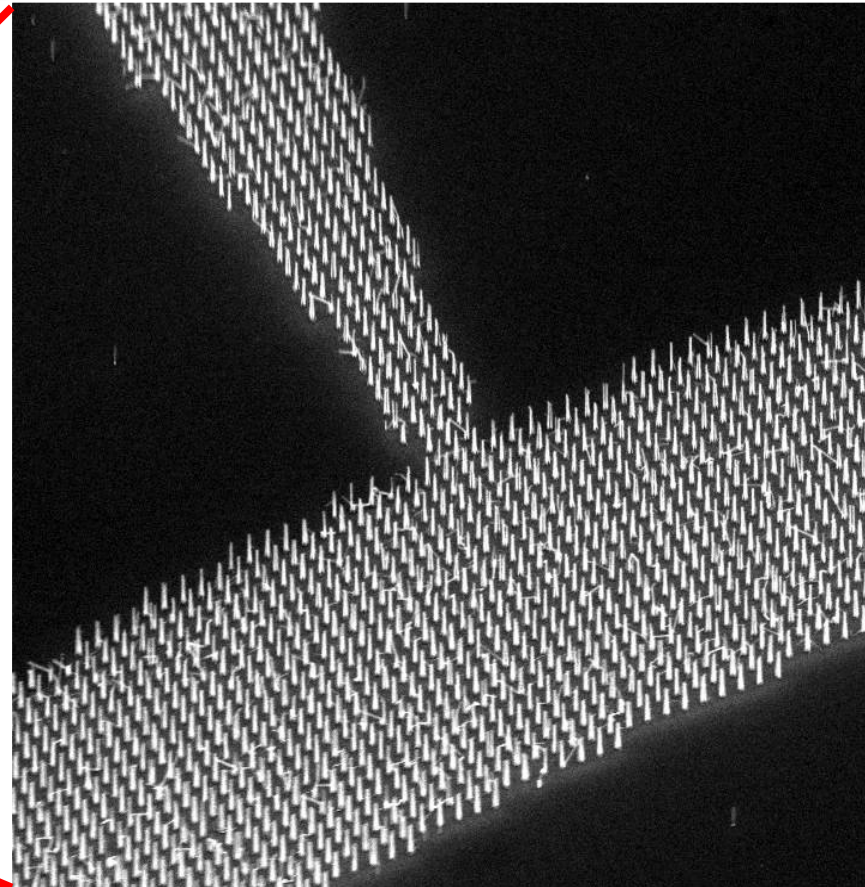
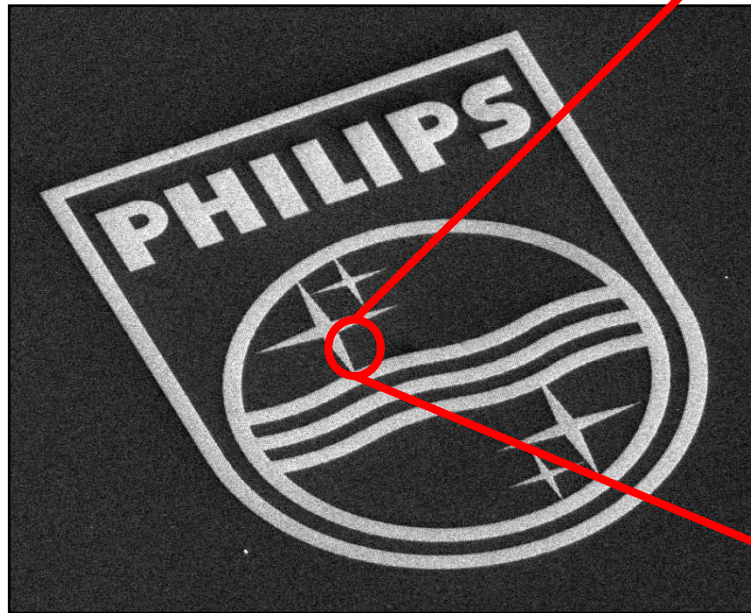
HSQ resist structures for fabrication of Ag nanoantennas (inset), CD: 15 nm



Fabrication scheme: e-beam + dry etching

Microelectronic Engineering 86 (2009) 1078-1080

Ultra-High Resolution E-Beam Lithography

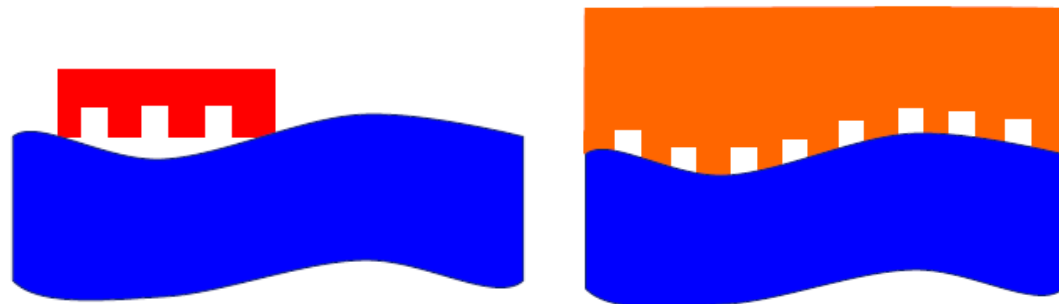


Lift-off process: 25 nm gold dots for nanowire growth.

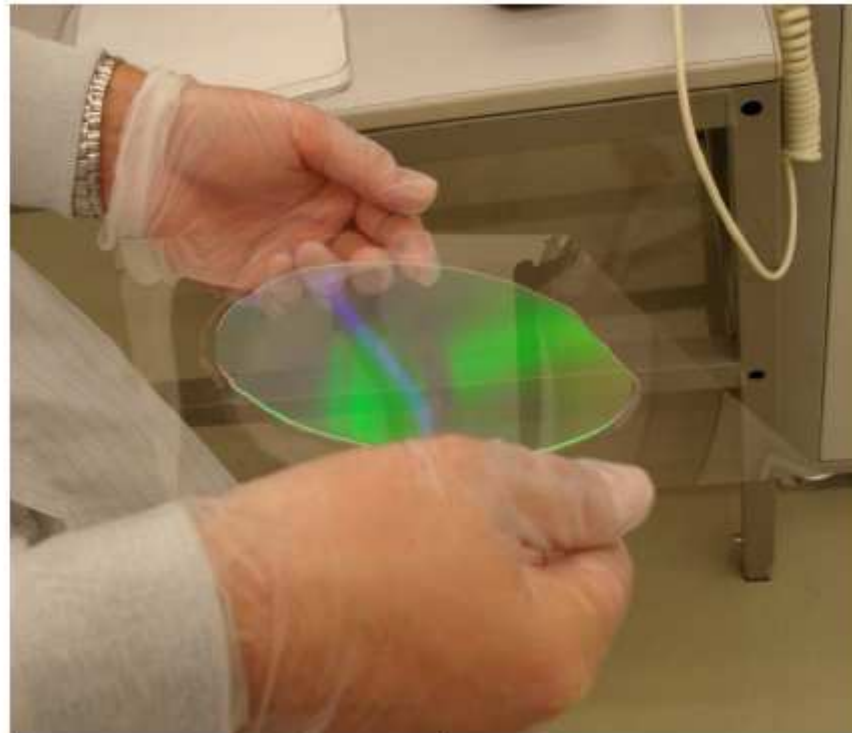
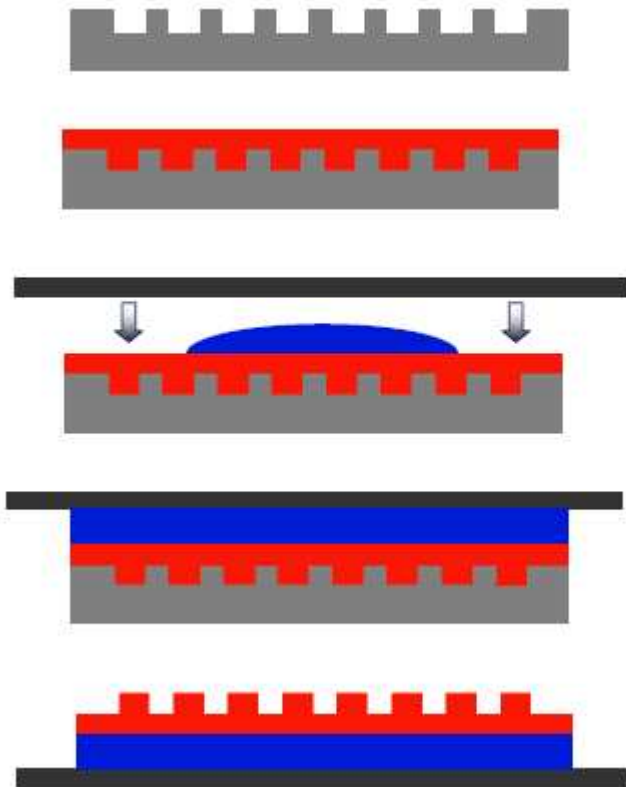
NIL vs. soft printing



	NIL hard stamp	SL soft stamp
speed	+	+
low costs	+	+
resolution	+	+
placement accuracy	+	0
pattern fidelity	+	-
release	0	+
dealing with dust	-	+



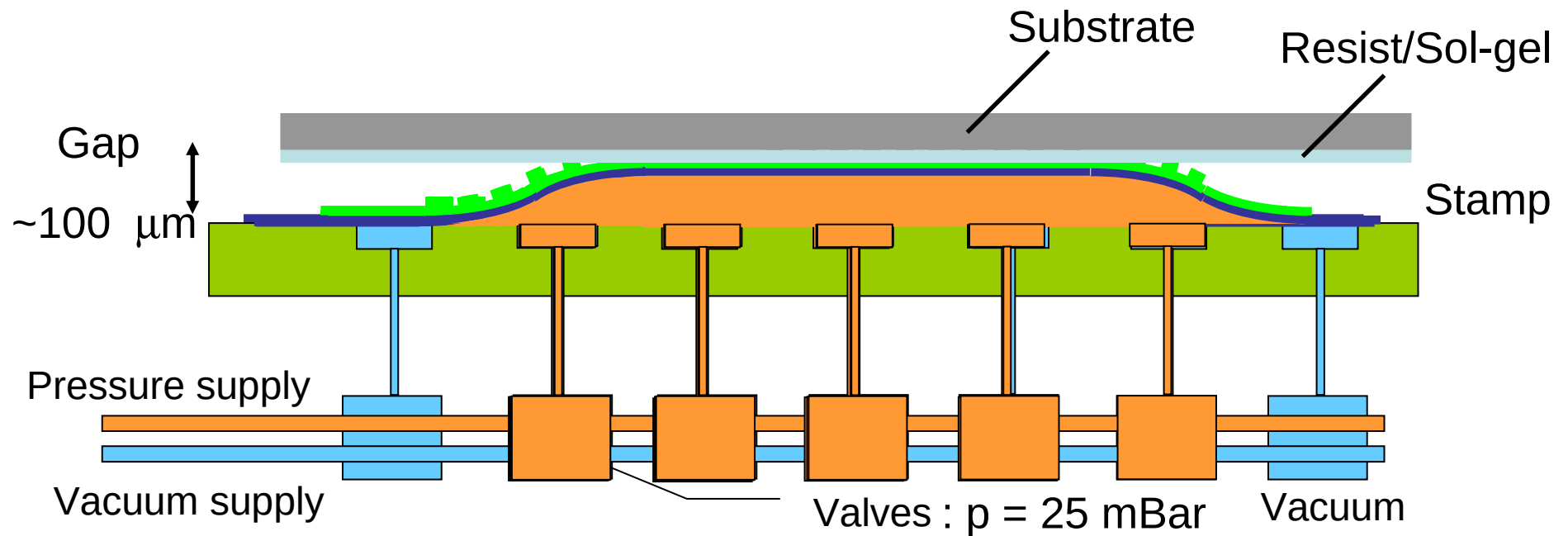
SCIL - Substrate Conformal Imprint Lithography



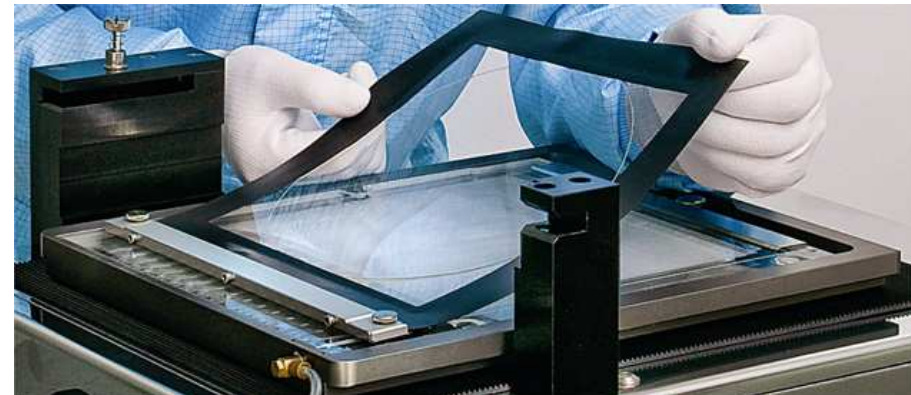
SCIL composite stamp

	NIL	SL	SCIL
speed	+	+	+
low costs	+	+	+
resolution	+	-	+
placement accuracy	+	-	+
pattern fidelity	+	-	+
release	-	+	+
dealing with dust	-	+	+

SCIL printing principle

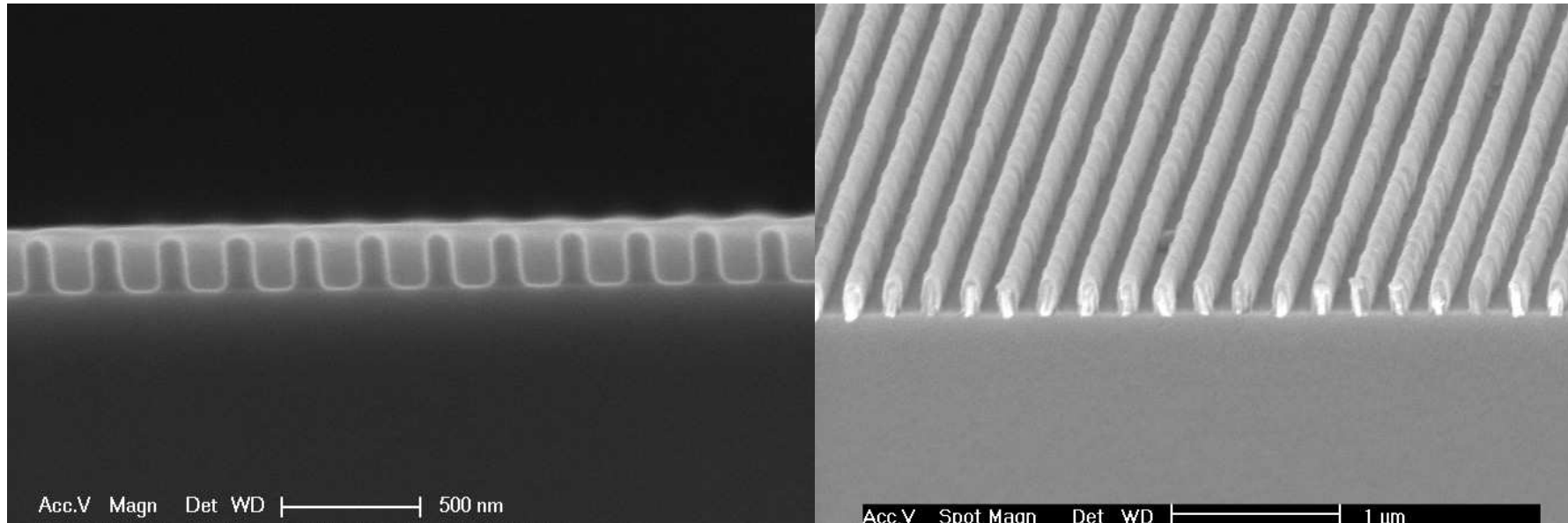


SCIL - Substrate Conformal Imprint Lithography



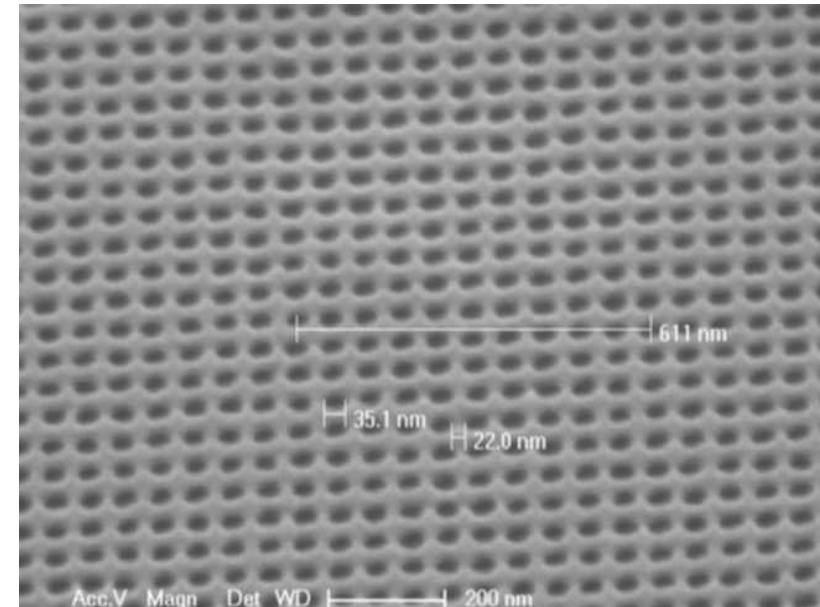
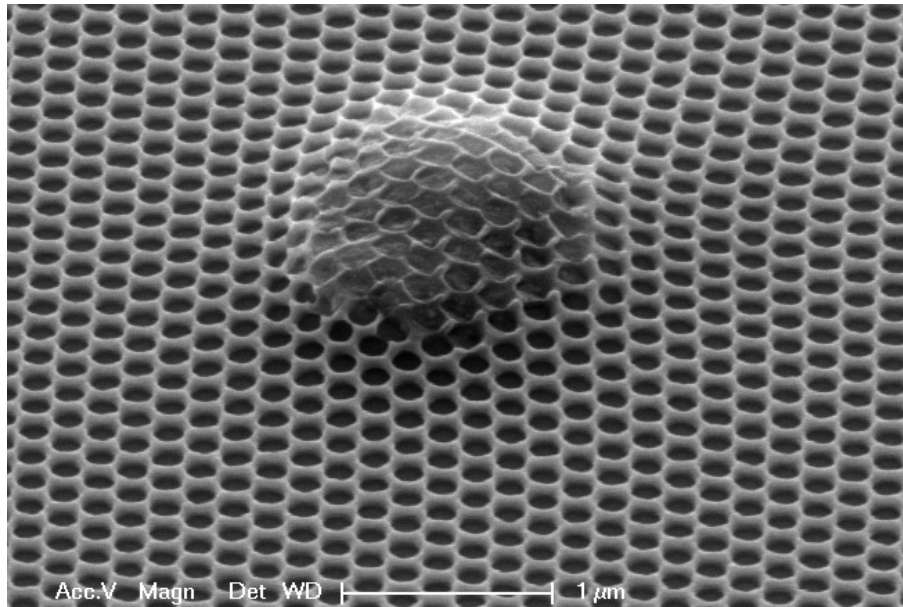
SCIL imprint module on Süss MA 6/8 mask aligner

E-beam $\rightarrow$ SCIL



- Creating quartz-like templates from patterned and cured sol-gel material on quartz substrates
- Using resist or sol-gel material as etch mask for transferring pattern into other materials

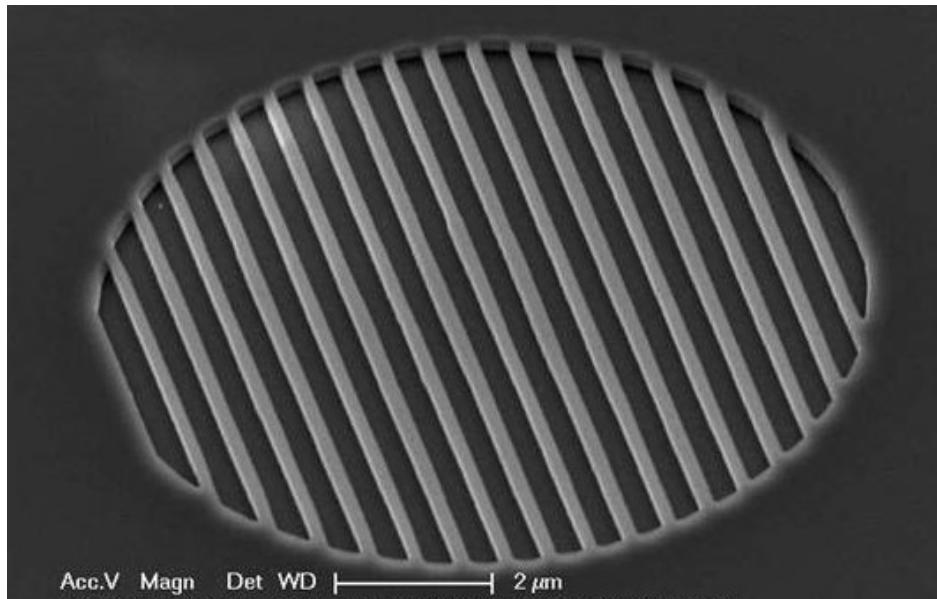
E-beam → SCIL



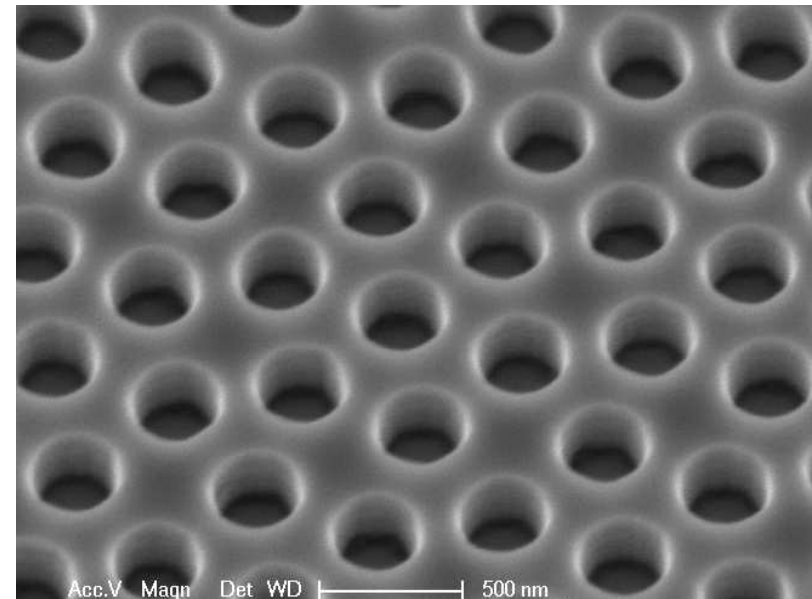
Substrate conformal: no stamp damage
& only local deformations

High resolution – 30nm dense dot array

E-beam $\rightarrow$ SCIL

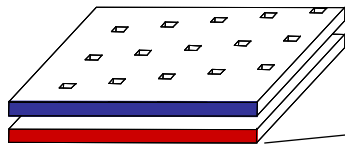


gratings for VCELs
(picture courtesy Ulm Photonics)

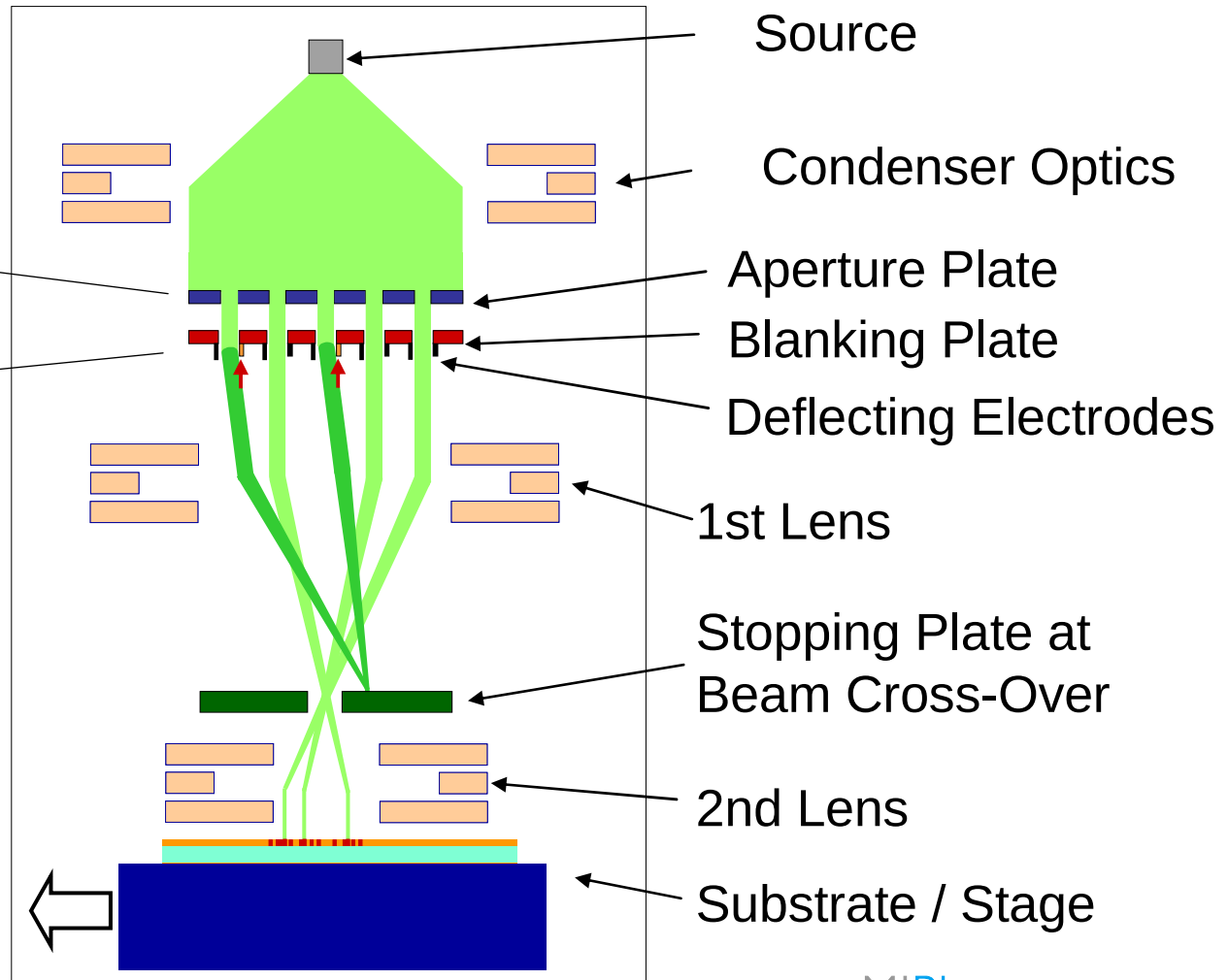


photonic crystal etched in GaN

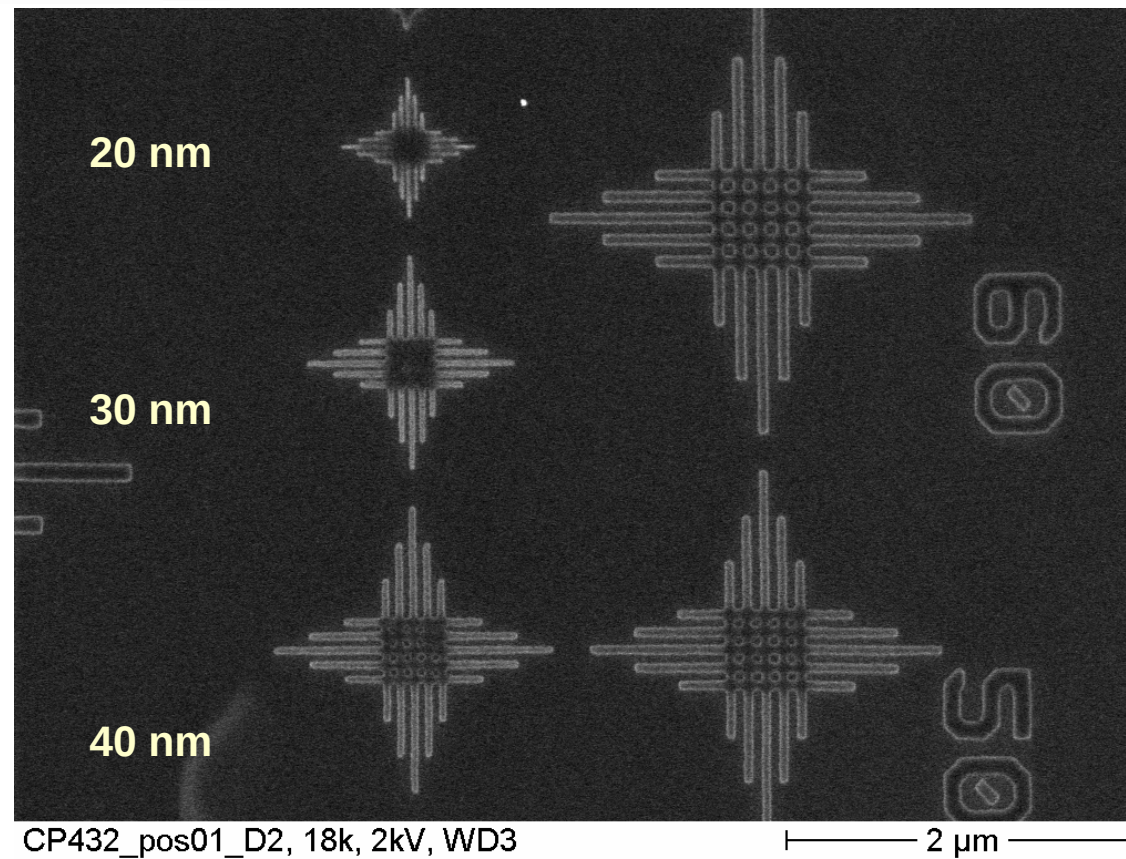
APS
programmable
Aperture Plate System



200x reduction
projection optics



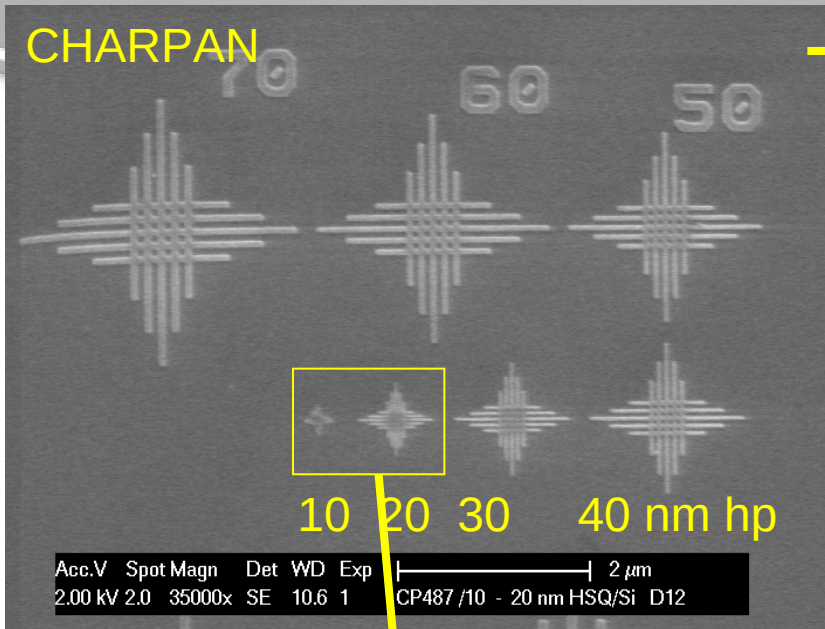
**1:1
L & S**



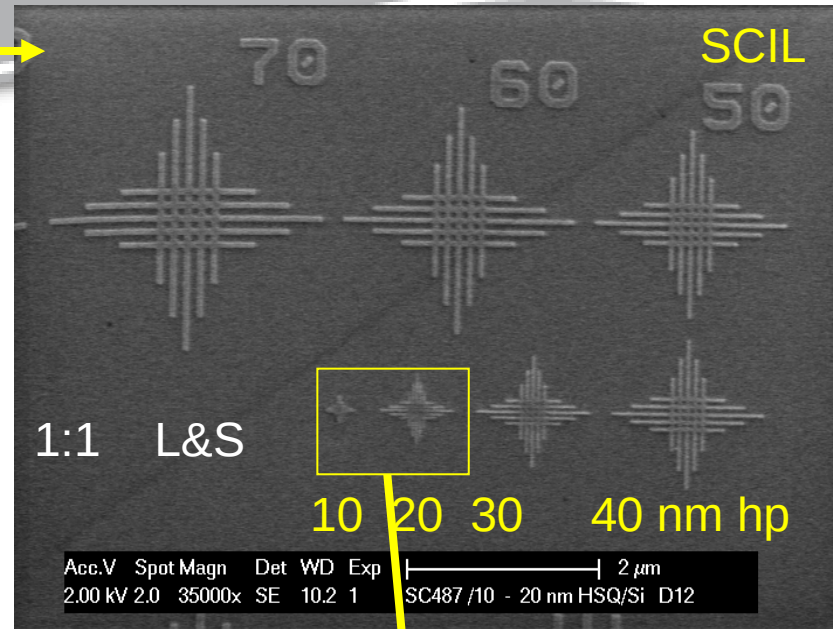
CHARPAN CMOS-APS exposure result: 10keV H_3^+ $\Rightarrow$ 20nm HSQ

Charpan → SCIL

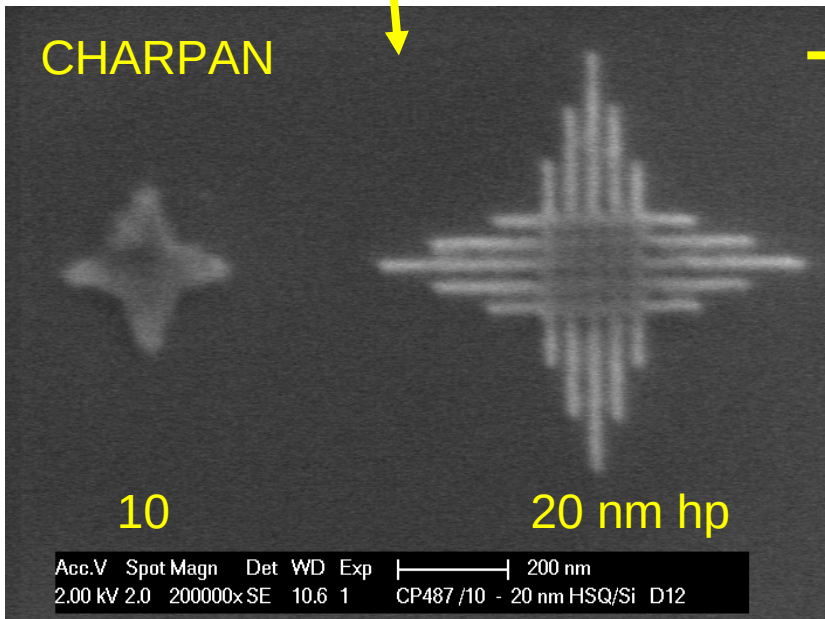
CHARPAN



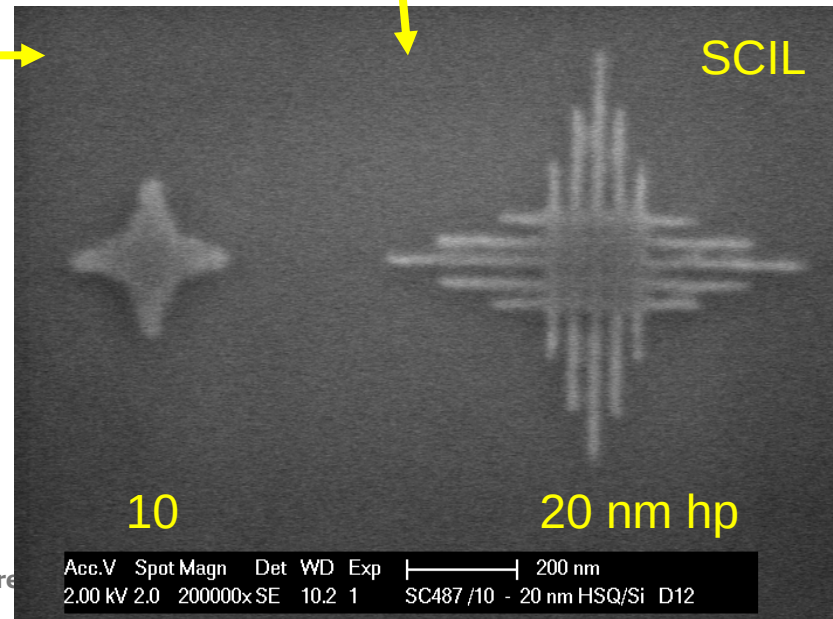
SCIL



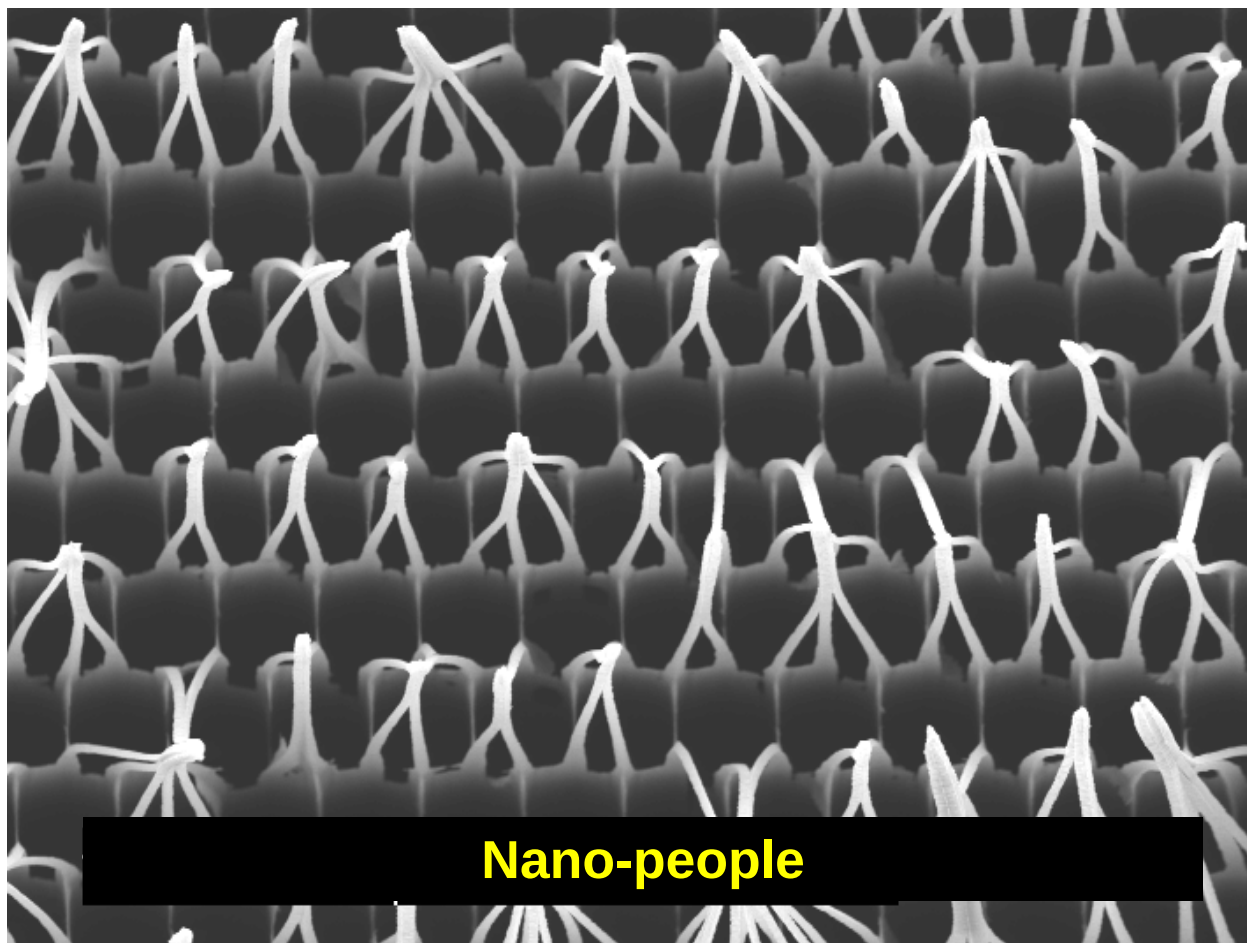
CHARPAN



SCIL



- ★ **Optical lithography (> 400nm)**
- ★ **Direct write by e-beam**
- ★ **Nano-imprint by SCIL with e-beam master**
- ★ **Comprehensive set of adjacent enabling technologies,
like deposition, etching, measuring,**



Nano-people